

PATENT APPLICATION

Methods for Calibrating an Interferometer Apparatus, for Qualifying an Optical Surface, and for Manufacturing a Substrate Having an Optical Surface

Inventors: **Rolf FREIMANN**
Residence: Aalen, Germany
Citizenship: Germany

Bernd DÖRBAND
Residence: Aalen, Germany
Citizenship: Germany

Assignee: **Carl Zeiss SMT AG**
Carl-Zeiss-Strasse 22
D-73447 Oberkochen, Germany
Incorporation: Germany

Entity: Large

5 **Methods for calibrating an interferometer apparatus, for
 qualifying an optical surface, and for manufacturing a
 substrate having an optical surface**

Field of the Invention

10 The present invention relates to the field of measuring and
 manufacturing optical surfaces. In particular the invention
 relates to a method for calibrating an interferometer
 apparatus for measuring an optical surface and/or a method
 for qualifying the optical surface by using the apparatus
15 and/or a method for manufacturing an optical surface by using
 the interferometer apparatus.

Background of the Invention

20 The substrate having the optical surface is, for example, an
 optical component such as an optical lens or an optical
 mirror used in optical systems, such as telescopes used in
 astronomy, or systems used for imaging structures of a mask
 ("reticle") onto a radiation sensitive substrate ("resist")
 in a lithographic method. The success of such an optical
25 system is substantially determined by the precision with
 which the optical surface can be machined or manufactured to
 have a target shape. In such manufacture it is necessary to
 compare the shape of the machined optical surface with its
 target shape, and to determine differences between the
30 machined and target surfaces. The optical surface is then
 further machined at those portions where differences between
 the machined and target surfaces exceed e.g. a predefined
 threshold.

35 Interferometric apparatuses are commonly used for high
 precision measurements of optical surfaces. Examples of such

apparatus are disclosed in US 4,732,483, US 4,340,306, US 5,473,434, US 5,777,741, US 5,488,477, which documents are incorporated herein by reference.

5 The conventional interferometer apparatus usually includes a reference surface which is illuminated with measuring light, and measuring light reflected back from the reference surface is imaged on a detector. Further, the optical surface to be measured is arranged in a same or separate beam of measuring
10 light, and the optical surface is also imaged on the detector by using light reflected from the optical surface to be measured. The light reflected from the optical surface and the reference surface generate an interference pattern on the detector. By analyzing this pattern, shape differences
15 between the reference surface and the optical surface to be measured can be determined in terms of wavelengths of the measuring light. Thus, the first approach to interferometrically measuring the optical surface allows the determination of the shape thereof only relative to the shape
20 of the reference surface, the shape of which has to be determined by some independent procedure.

The deviation of an optical surface from its target surface is referred to as surface error in the following. The surface
25 errors of an optical surface having a rotationally symmetric target surface may be separated in rotationally symmetric errors and rotationally asymmetric errors. The rotationally asymmetric errors of an optical surface may be absolutely measured according to a method disclosed in the article by R.
30 Freimann et. al., "Absolute measurement of non-comatic aspheric surface errors", Optics Communications 161 (1996), pages 106 to 114, or as disclosed in US 2002/0063867A1. Here, the term "absolute measurement" means that the determined surface errors are absolute errors rather than relative
35 errors depending on the shape of a reference surface. In this method optical path differences between the surface to be

measured and the reference surface of the interferometer are separately measured for plural angular positions with respect to the optical axis of the surface to be measured. The plural measurements are averaged and represent the symmetric surface errors relative to the reference surface. Subtracting the averaged phase differences from the phase differences measured in one particular angular position will then result in a representation of the absolute asymmetric surface errors, however.

There are only few methods known for absolute measurement of rotationally symmetrical surface errors. One such method is illustrated in the article of P. Hariharan, Optical Engineering 36 (9), pages 2478 to 2481, September 1997, using an auxiliary mirror and at least two measuring positions involving high demands on mechanical precision of a measuring apparatus. A further method of such type is disclosed in the article of B.S. Fritz, "Absolute Calibration of an Optical Flat, Optical Engineering 23, page 379, 1984, involving three optical flats and two additional optical wedges of a big size and thermal and mechanical stability.

A method for the determination of the three-dimensional refractive index distribution of a GRIN-lens with plane surfaces is disclosed in US patent application US 2002/0191193 A1.

Further, it is an object of the present invention to provide an improved method for qualifying an optical surface. It is also an object of the present invention to provide an improved method of manufacturing an optical surface.

Summary of the Invention

The forgoing objects are accomplished by providing a method for calibrating an interferometer apparatus for measuring an optical surface, wherein the method comprises four

interferometric measurements of one and the other optical surface of a transparent substrate and of a mirror surface. An inventive method of qualifying an/or manufacture of an optical surface then involves interferometric measurement of the optical surface using the interferometer apparatus calibrated according to the above method. Further, the optical surface to be qualified or manufactured may be used in the method for calibrating the interferometric apparatus as one of the surfaces of the transparent substrate, or the mirror surface.

According to a preferred embodiment the four measurements include:

- measurement of a second surface of the transparent substrate by internally reflecting a measurement beam from the second surface through a first surface of the substrate;
- flipping the transparent substrate and measuring the second surface by externally reflecting the measuring beam from the second surface;
- measuring a mirror surface by reflecting the measuring beam therefrom wherein the transparent substrate is not placed in the measuring beam;
- measuring the mirror surface through the first and second surfaces of the transparent substrate arranged in the measuring beam.

Herein, all the above four measurements may be performed with respect to a reference surface of the interferometer.

If the transparent substrate has two substantially parallel surfaces the measurement of the second surface through the first surface thereof may be performed with respect to the reference surface of the interferometer or with respect to the first surface of the substrate.

The method of manufacturing the optical surface further includes machining of the optical surface after measuring the same, wherein the machining is performed in dependence of deviations of the measured optical surface from its target shape.

According to a preferred embodiment the method of manufacturing includes a final finishing of the machined optical surface.

The forgoing, and other features, and advantages of the invention will be more apparent from the following detailed description of preferred embodiments of the invention with reference to the accompanying drawings.

Brief description of the drawings.

Figure 1 illustrates a first embodiment of a method for calibrating an interferometer apparatus and for qualifying an optical surface.

Figure 2 is a flow chart of a method of manufacture for the optical surface qualified by the method illustrated in figure 1.

Figure 3 illustrates a second embodiment of a method for calibrating an interferometer apparatus and for qualifying an optical surface.

Figure 4 shows a cross-section through a transparent substrate used in the method according to figure 3.

Figure 5 illustrates a third embodiment of a method for calibrating an interferometer apparatus and for qualifying an optical surface.

Detailed description.

The embodiments of methods illustrated below involve interferometrically taking measurements of wavefronts generated by reflecting an incident beam provided by an interferometer apparatus from surfaces to be measured. Plural conventional interferometric methods may be used for taking such measurements. Examples of such interferometric methods are disclosed in e.g. US 5,361,312, US 5,982,490 and US 2002/0063867A1. The full disclosure of these patents and publications are incorporated herein by reference. An example of an interferometric method for measuring a first surface wherein a second surface parallel to the first surface is located in the beam path together with a reference surface is disclosed in US 5,488,477 or Appendix A (a translation of WO 03/002933), wherein the full disclosure of these documents is incorporated herein by reference.

Figure 1 illustrates a method of qualifying an optical surface 11 provided on a substrate 13 (figure 1f). The surface 11 may be, for example, a mirror surface or a transmissive surface when the substrate 13 is transparent. In the embodiment of figure 1 the surface 11 to be qualified is a substantially flat surface. One goal of the method is to determine deviations of surface 11 from a flat target shape.

In figure 1f there is shown a method step of interferometrically taking a measurement of optical surface 11 by using a parallel beam 15 of measuring light incident on surface 11 wherein the beam 15 is provided by an interferometer optics, which is schematically represented by box 17 in figure 1. The interferometer optics may be of any conventional type, and in particular of a type disclosed in US 5,361,312, US 5,982,490, US 2002/0063867A1, US 5,488,477 or Appendix A (WO 03/002933).

In the beam path between interferometer optics 17 and optical surface 11 a reference surface 19 is provided, which is also a flat surface. Wavefronts of beam 15 reflected from the reference surface 19 interfere with wavefronts reflected from optical surface 11 on a light sensitive surface of a detector (not shown in figure 1) of the interferometer optics 17. An interference pattern generated by the detector will then be analyzed to produce a map representing an optical path difference between reference surface 19 and optical surface 11. Thus, optical surface 11 has been measured relative to the reference surface.

For determining deviations of optical surface 11 from its flat target surface a calibration of the interferometer 17 and its reference surface 19 is necessary. Such calibration is accomplished by performing the measuring steps illustrated in figures 1a through 1e.

In a measuring step shown in figure 1a, a wedge shaped transparent substrate 21 having a first flat surface 23 and a second flat surface 25, is placed in the beam path of incident beam 15, such that the first surface 23 is facing towards the interferometer optics and reference surface 19, and further, such that measuring light beam 15 is substantially orthogonally incident on the first surface 23. A first interferometric measurement of first surface 23 is performed by allowing wave fronts reflected from first surface 23 and wave fronts reflected from reference surface 19 to interfere on the detector of interferometer optics 17. From the detected interference pattern a map W_1 is generated representing optical path differences between reference surface 19 and first surface 23. This map may be represented by

$$W_1 = W_{int} + 2h_1 \quad (1)$$

wherein W_{int} is a (yet unknown) map representing deviations of reference surface 19 from a perfectly flat surface and wherein h_1 represents deviations of first surface 23 from a perfectly flat surface. In this application the following convention with respect to signs of deviations is observed:

A deviation W of a wavefront is assigned a positive sign if the deviated wavefront advances the undeviated wavefront in the direction of travel. A deviation h of a surface is assigned a positive sign if it points outwardly away from the optical component on which it is provided.

In the step shown in figure 1b substrate 21 is oriented such that a wavefront reflected from second surface 25 is allowed to interfere with the wavefront reflected from reference surface 19. This means that, compared to figure 1a, wedge shaped substrate 21 is tilted such that first surface 23 does not contribute to the interference pattern generated on the detector of interferometer optics 17. From the detected interference pattern a map W_1 is generated representing path differences between reference surface 19 and second surface 25 wherein W_2 may be written as

$$W_2 = W_{int} - 2(n-1)h_1 - 2n \cdot h_2 + i \quad (2)$$

wherein n is the average refractive index of the medium of substrate 21, h_2 is the deviation of second surface 25 from the perfectly flat surface, and i is the local deviation of the refractive index n of the medium of substrate 21.

In a step shown in figure 1c, and compared to figure 1b, substrate 21 is flipped or rotated about a horizontal axis by 180° such that wavefronts reflected back from the external surface of surface 25 are allowed to interfere with wavefronts reflected back from reference surface 19. From the

detected interference pattern a map W_3 is determined which may be written in the form

$$W_3 = W_{int} + 2 h_2 \quad (3)$$

5

In a step shown in figure 1d substrate 21 is removed from the beam path of incident beam 15 and an auxiliary mirror 29 with its mirror surface 31 is arranged in the beam path of incident beam 15 such that wavefronts reflected from mirror surface 31 are allowed to interfere with wavefronts reflected from reference surface 19 on the detector of the interferometer optics 17. From the detected interference pattern a map W_4 representing path differences between reference surface 19 and mirror surface 31 is generated. Map W_4 may be written as

10

15

$$W_4 = W_{int} + 2 h_m \quad (4)$$

20

wherein h_m represents deviations of mirror surface 31 from the perfectly flat shape.

25

30

35

In a step shown in figure 1e mirror 29 is in the same position as shown in figure 1d. However, substrate 21 is arranged in the beam path between reference surface 19 and mirror surface 31, such that the first surface 23 of substrate 21 faces towards the interferometer optics 17 and reference surface 19. Further, compared to figures 1a and 1b, the wedge shaped substrate 21 is tilted such that none of the first surface 23 and second surface 25 of the substrate 21 substantially contributes to an interference pattern generated by wavefronts reflected back from reference surface 19 and mirror surface 31. The measuring beam 15 passes through substrate 21 which effects the transmitted beam due to deviations from its prescribed properties, such as surface shape and homogeneity of the refractive index of its medium. From the detected interference pattern a map W_5 representing

path differences between reference surface 19 and mirror surface 31 is generated. Map W_5 may be written as

$$W_5 = W_{int} + 2h_m - 2(n-1)h_1 - 2(n-1)h_2 + i \quad (5)$$

5

By performing the steps shown in figures 1a through 1e, the interferometer 17 with its reference surface 19, the first surface 23 and the second surface 25 of substrate 21 and the local deviations of the refractive index of the substrate 21 are completely calibrated and may be determined from the equations below. At first, a difference W_D between maps W_5 and W_4 may be rewritten as

10

$$W_D = W_5 - W_4 = -2(n-1)h_1 - 2(n-1)h_2 + i \quad (6)$$

15

From formulas 1 through 6 above the deviations h_1 of first surface 23 of substrate 21 from the perfectly flat surface may be written as h_1

$$h_1 = \frac{1}{4} (2W_1 - W_2 - W_3 + W_D) \quad (7)$$

20

Similarly, the deviations of second surface 25 of substrate 21 from the perfectly flat surface may be written as

$$h_2 = \frac{1}{4} (-W_2 + W_3 + W_D) \quad (8)$$

25

Further, the deviations of the refractive index of substrate 21 may be written as i

$$i = (n-1) (W_1 - W_2) + n W_D \quad (9)$$

30

Finally the interferometer error or deviations of the shape of wavefronts generated by the interferometer 17 and reference surface 19 deviating from plane wavefronts may be represented as W_{int}

35

$$W_{\text{int}} = \frac{1}{2} (W_2 + W_3 - W_D) \quad (10)$$

In the step shown in figure 1f wavefronts reflected back from reference surface 19 are allowed to interfere with wavefronts reflective from optical surface 11 to be qualified and manufactured, and a map W_6 generated from an interference pattern detected in this step may be written as W_6

$$W_6 = W_{\text{int}} + 2h_0 \quad (11)$$

10

wherein h_0 represents deviations of optical surface 11 from its perfectly flat shape. Thus, it is possible to qualify optical surface 11 in absolute terms with respect to a perfectly flat surface rather than merely determining optical surface 11 relative to reference surface 19 to be calibrated independently.

15

Equation (11) may be rewritten as

20

$$h_0 = \frac{1}{2} (W_6 - W_{\text{int}}) \quad (12)$$

which represents a map of deviations of optical surface 11 from its perfectly flat shape, wherein W_{int} is determined according to equation (11).

25

Having qualified optical surface 11 it is then possible to identify those regions on surface 11 where deviations from the flat shape exceed a certain threshold. A machining step is then performed to reduce these deviations. The machining may comprise polishing or ion beam etching and other methods.

30

Thereafter, the measurement according to figure 1f is repeated to determine a new map h_0 of deviations of surface 11 from its flat target surface. If these deviations still exceed the predetermined threshold a further machining step is performed. Otherwise, a finishing step is performed on the

35

optical surface 11. The finishing may include a final polishing of the surface or depositing a reflection coating or an anti-reflection coating. A reflection coating may include, for example, a plurality of material layer pairs, for example 40 pairs of alternating molybdenum and silicon layers or other conventional layers.

Thicknesses of these latter layers may be about 5 nm and will be adapted to a wavelength to be reflected from the optical surface, such that a reflection coefficient is substantially high. Finally, the reflection coating may be covered by a cap layer for passivating the reflection coating. The cap layer may include a layer formed by depositing ruthenium, for example.

An anti-reflection coating which is intended to reduce reflections of radiation of an interface of an optical element, such as a lens element, may include magnesium fluoride or lanthanum oxide or other conventional materials. The above mentioned threshold value will differ from the application of the optical surface in the optical system for which it is designed. For example, if the optical surface is a lens surface in an objective for imaging a reticle structure onto a resist with radiation of a wave length $\lambda = 193$ nm, such threshold value may be in a region of about 2 nm to 10 nm, and if the optical surface will be used as a mirror surface in an imaging objective using EUV (extreme ultraviolet) radiation with a wave length of $\lambda = 13.5$ nm, the threshold value will be in a region of about 0.1 nm to 1.0 nm.

From the above it appears that for determining the deviations h_0 of optical surface 11 it is not necessary to perform the step of figure 1a since the map W_1 determined therein (see equation (1)) does not enter into equation (12).

The method of manufacturing optical surface 11 is summarized with reference to figure 2:

After providing the interferometer optics 17 with its
5 reference surface 19 the auxiliary wedge shaped substrate 21 is arranged in the interferometer beam path in a step S11 as shown in figure 1a. Thereafter, the first surface 23 of substrate 21 is measured, and map W_1 according to equation (1) is calculated in a step S13. Thereafter, in a step S15,
10 the wedge 21 is rearranged for measuring its second surface 25 and determining map W_2 .

Wedge 21 is flipped or reversed in step S17 such that its second surface 25 faces the interferometer, and map W_3 is
15 determined in S19. Thereafter, in a step S21, wedge 21 is flipped back to its orientation in step S11, but tilted such that none of its first or second surfaces contributes to an interference pattern generated by reflecting the interferometer beam back from the auxiliary mirror 29. Mirror
20 surface 31 is measured in step S23 and map W_5 is generated.

In a step S25 wedge 21 is removed, and the mirror surface is measured for determining map W_4 in step S27. Thereafter, in step S29 the auxiliary mirror is removed and the optical
25 surface 11 to be qualified and manufactured is mounted in the beam path in a step S31. Optical surface 11 is measured in a step S33 in which map W_6 is determined. In a following step S35 differences h_0 between optical surface 11 and its target surface, i.e. the flat surface, are determined from maps W_2 ,
30 W_3 , W_4 , W_5 and W_6 in step S35.

In a decision step S37 it is determined whether the differences determined in step S35 are below a pre-determined threshold. If not, the optical surface 11 is machined in a
35 step S39 to reduce these differences, and the method is continued with step S31, i.e. mounting the optical surface in

the interferometer beam path again. If the differences are below the threshold the optical element 13, including its optical surface 11, undergo a finishing procedure in a step S41 and the optical element is delivered in a step S43.

5

It is to be noted that it is not necessary that the above-mentioned threshold is a constant threshold over the whole area of the optical surface. It is possible that the threshold is dependent on e.g. a distance from a center of the surface or some other parameter.

10

Further, all measurements illustrated above with reference to figure 1 may be repeated with arranging the measured surfaces 23, 25, 31 and 11 under plural different angular positions with respect to an optical axis 35 of the interferometer 17.

15

Further, the steps shown in figures 1a through 1f may be performed in any order as already indicated in figure 2 where the determination of map W_5 is performed before determination of map W_4 . However, in particular steps according to figures 1b and 1e may be performed in any order. Further, for merely determining h_0 it is not necessary to perform step S13 according to figure 1a for determining map W_1 .

20

In the method illustrated above with reference to figure 1, substrate 21 is arranged in the step illustrated in figure 1e in the same orientation as in the step illustrated in figure 1b, i.e. in both steps the first surface 23 of substrate 21 faces towards reference surface 19. However, it is also possible to perform the step corresponding to figure 1e such that substrate 21 has an orientation as shown in figure 1c, i.e. first surface 23 of substrate 21 faces away from reference surface 19.

30

In the above manufacturing method illustrated with reference to figures 1 and 2, the optical surface to be manufactured is

35

different from the surfaces 23 and 25 of substrate 21 and mirror surface 31 of mirror 29. It is, however, possible that surface 23 of substrate 21 is to be machined to be a flat surface. Then h_1 determined according to equation (7) may be compared to a threshold for determining regions of surface 23 which need further machining. Similarly, deviations of surface 25 from its flat target surface may be determined according to equation (8) and machining of surface 25 may be performed accordingly.

Further, a map h_M for mirror surface 31 may be determined according to

$$h_M = \frac{1}{4} (2W_4 - W_2 - W_3 + W_D), \quad (13)$$

and machining of mirror surface 31 may be performed after a comparison of h_M with a threshold, for manufacturing a flat mirror.

In the following further embodiments of the invention will be illustrated with reference to figures 3 to 5. Herein, the same reference numerals are assigned to components which correspond to components illustrated in the previous embodiment with reference to figures 1 and 2. However, an additional letter is assigned to the reference numerals for distinguishing purposes.

Figure 3 illustrates a method for qualifying a spherical optical surface 11a of a mirror 13a. This qualification is performed in a step illustrated in figure 3f which is similar to the step illustrated in figure 1f. Again an interferometer optics 17a is used to provide a parallel beam 15a of measuring light which passes a reference surface 19a for reflecting back wavefronts to the interferometer. However, a lens 39 is provided in beam 15a to transform the parallel beam 15a into a convergent beam 16 which passes through a

cross-over region 18 on an optical axis 35a of the interferometer optics 17a. After passing the cross-over region the incident beam of measuring light forms a diverging beam 20 which is incident on optical mirror surface 11a which is rotationally symmetrically arranged with respect to the optical axis 35a.

In this arrangement wave fronts of divergent beam 20 reflected back from the optical surface 11a are allowed to interfere with wave fronts reflected back from reference surface 19a on a detector of the interferometer optics 17a. From a detected interference pattern a map h_0 representing relative optical path differences between mirror surface 11a and reference surface 19a may be derived, wherein map h_0 may be represented according to equation (12) above. From equation (12) it is apparent that the measurement shown in figure 3f is only a relative measurement of optical mirror surface 11a. For an absolute determination of surface errors of spherical surface 11a the interferometer 17a, including reference surface 19a, have to be calibrated by performing the method illustrated in figures 3a through 3e.

The method uses an auxiliary wedge shaped meniscus lens 21a illustrated in figure 4. Meniscus lens 21a has a concave spherical first surface 23a having a center of curvature M_1 , and a convex spherical second surface 25a having a center of curvature M_2 . The centers of curvature M_1 and M_2 are displaced transversely to optical axis 35a with respect to each other by an amount s , such that lens 21a is wedge shaped in that sense that its width in an upper portion in figure 4 is larger than a corresponding width in its lower portion. Such wedge shape has a function similar to that of the auxiliary substrate in the method according to figure 1, which is to avoid interference of wave fronts reflected back from first surface 23a with wave fronts reflected back from surface 25a.

In figure 4 the perfect spherical shape of first and second surfaces 23a and 25a is drawn with a thick line. The deviation from the perfect spherical shapes on both the first and second surfaces is shown with a thin line. Further,
 5 deviations from the spherical shape of the first and second surfaces are indicated as arrow h_1 and h_2 . From the direction of arrows h_1 and h_2 the sign convention used in this application is apparent. Surface deviations have a positive sign if they are oriented away from the substrate on which
 10 the respective surface is provided.

In a method step illustrated in figure 3a meniscus lens 21a is arranged in divergent incident beam 20 such that wave fronts reflected back from its first surface 23a are allowed
 15 to interfere with wave fronts reflected back from reference surface 19a. From the resulting interference pattern a map W_1 is generated which conforms to equation (1) above.

In a step shown in figure 3b the meniscus lens 21a is
 20 arranged such that wave fronts of divergent beam 20 incident on second surface 25a through first surface 23a and reflected back from second surface 25a through first surface 23a are allowed to interfere with wave fronts reflected back from reference surface 19a on the detector of interferometer
 25 optics 17a. From the detected interference pattern a map W_2 is generated which may be written in accordance with equation (2) above.

Compared to figure 3b the meniscus lens 23a is rotated about
 30 a horizontal axis by 180 degrees in figure 3c such that the second surface 25a faces towards lens 39 and such that second surface 25a is arranged such that convergent beam 16 is incident from the exterior or on faces towards reference surface 19a, and second surface 25a. Wave fronts reflected
 35 back from second surface 25a are allowed to interfere with wave fronts reflected back from reference surface 19a on the

detector of the interferometer optics. From the detected interference pattern a map W_3 representing optical path differences between second surface 25a and reference surface 19a is derived. Map W_3 may be written according to equation
 5 (3) above.

In a step illustrated in figure 3d wedge shaped lens 21a is removed from the interferometer beam path, and an auxiliary mirror 29a having a concave spherical mirror surface 31a is
 10 arranged in the divergent beam 20a such that wave fronts reflected back from mirror surface 31a are allowed to interfere with wave fronts reflected back from reference surface 19a. From a detected interference pattern a map W_4 representing optical path differences between mirror surface
 15 31a and reference surface 19a is generated. This map W_4 may be rewritten according to equation (4) above.

In a step shown in figure 3e the auxiliary mirror 29a is in the same position as in step shown in figure 3d. However, the
 20 meniscus lens is arranged in the divergent beam 20 such that its concave first surface 23a faces towards cross-over region 18. Further, wedge shaped lens 21a is oriented such that wave fronts of divergent beam 20a reflected back from its first or second surfaces 23a, 25a are not allowed to interfere with
 25 wave fronts reflected back from reference surface 19a. Wave fronts reflected back from reference surface 19a are allowed, however, to interfere with wave fronts reflected back from auxiliary mirror surface 31a. From a resulting interference pattern a map W_5 is generated which may be written according
 30 to equation (5) above.

Using formulas 6 to 12 above deviations of optical surface 11a of mirror 13a to be qualified or manufactured may be determined. Further, deviations h_1 and h_2 (see equations (7)
 35 and (8) above) of the first and second surfaces 23a and 25a of meniscus lens 21a may be calculated. Further, deviations i

of the index of refraction of the medium of meniscus lens 21a from its average value n may be determined by using equation (9) above. Further, the interferometer errors including deviations of reference surface 19a from its target shape may
 5 be represented by using equation (10) above.

Since h_1 and h_2 may be determined it is also possible to manufacture meniscus lens 21a to a high precision using the qualifying method illustrated above. Further, using formula
 10 (13) above it is possible to qualify surface 31a of auxiliary mirror 29a such that this surface may also be machined to a high precision.

In figure 5 a further method for qualifying flat surfaces is
 15 illustrated. Different from the method illustrated in Figure 1, an auxiliary transparent substrate 21b used in the method illustrated in figure 5 has first and second surfaces 23b and 25b which are parallel to each other. By using the equations developed above it is possible to use the method illustrated
 20 in figure 5 as a method of qualifying substrates having two parallel surfaces. However, a substrate having two parallel surfaces 23b and 25b arranged in a beam 15b of measuring light provided by an interferometer 17 will exhibit the following peculiarity:

25 Referring to figure 5b where substrate 21b is arranged in incident beam 15b such that its second surface 25b faces away from the interferometer 17b and such that the second surface 25b is imaged on the detector of the interferometer. In such
 30 a situation wavefronts reflected back from second surface 25b will interfere with wavefronts reflected back from first surface 23b of substrate 21b. To avoid further interference of wavefronts reflected from reference surface 19b with wavefronts reflected from first and second surfaces 23b and
 35 25b, reference surface 19b is slightly tilted away from its orthogonal orientation with respect to optical axis 35b. A

map W_{fr} generated from an interference pattern obtained by wavefronts reflected back from a first (front) surface 23b interfering with wavefronts reflected back from second (rear) surface 25b may be written as

5

$$W_{fr} = -2nh_1 - 2n \cdot h_2 + i \quad (14)$$

All other steps shown in figure 5a, 5c, 5d, 5e and 5f correspond to steps shown in figures 1a, 1c, 1d, 1e and 1f, respectively.

10

In a step shown in figure 5a wavefronts reflected back from first surface 23b of substrate 21b interfere with wavefronts reflected back from reference surface 19b, and a map W_1 which may be represented according to equation (1) is generated.

15

In a step shown in figure 5c wavefronts reflected back from second surface 25b of reverted substrate 21b are allowed to interfere with wavefronts reflected back from reference surface 19b. A map W_3 is generated from the resulting interference pattern where in map W_3 may be represented according to equation (3) above.

20

In a step shown in figure 5d wavefronts reflected back from a mirror surface 31b of an auxiliary mirror 29b are allowed to interfere with wavefronts reflected back from reference surface 19b, and a map W_4 is generated which obeys equation (4) above.

25

In a step shown in figure 5e the substrate 21b is placed in the beam path between reference surface 19b and auxiliary mirror surface 31b such that surfaces 23b and 25b thereof do not contribute to the resulting interference pattern. A map W_5 is generated which may be represented according to equation (5) above.

30

35

If a substrate 13b which is different from substrate 21b or mirror 29b has a flat surface 11b which has to be qualified using the interferometer optics 17b it is then possible to perform a step shown in figure 5f where a map W_6 representing optical path differences between reference surface 19b and flat optical surface 11b is generated. This map W_6 may be written according to equation (11) above. Deviations h_0 of measured optical surface 11b from its flat target shape may be represented according to equation (12) above wherein W_{int} of this equation is calculated using W_{fr} determined in the step according to figure 5 according to

$$W_{int} = \frac{1}{2} (W_1 + W_{fr} + W_3 - W_D) \quad (15)$$

The deviations h_1 of the first surface 23b of substrate 21b and the deviations h_2 of second surface 25b of substrate 21b may be calculated according to:

$$h_1 = \frac{1}{4} (W_1 - W_{fr} - W_3 + W_D) \quad (16)$$

$$h_2 = \frac{1}{4} (-W_1 - W_{fr} + W_3 + W_D) \quad (17)$$

Further, the linear components of the local deviation i of the refractive index can be obtained from steps illustrated in Figs. 5b, 5d and 5e, because the unknown tilt of substrate 21b does not enter the measured wavefronts. These linear components of i are contained in e.g. (9) and can be extracted via Zernike-Fit of linear terms. In addition a residual mechanical wedge of substrate 21b can be obtained from these three steps and from

$$h_1 + h_2 = \frac{W_D - W_{fr}}{2} = \frac{1}{2} (W_5 - W_4 - W_{fr}). \quad (18)$$

This method of determining a mechanical wedge is unique in the sense that it is an optical method and that it measures the wedge across the whole substrate and not locally.

5 The disadvantage of complicated interference fringes generated by three interfering wavefronts reflected back from the first and second surfaces 23b and 25b of substrate 21b and from reference surface 19b may be avoided by using an
interferometer system and method as disclosed in US 5,488,477 or
10 Appendix A (WO 03/002933) in which an external cavity diode laser (ECDL) is used for generating the measuring beam of the interferometer. By generating measuring light of different frequencies and averaging the resulting interference pattern it is possible to suppress an undesirable influence of a
15 reflection from a particular surface in the interference pattern.

Further, an interferometer system and method may be employed using light having a coherence length shorter than a distance
20 between adjacent parallel surfaces to suppress the above mentioned problems of having three parallel reflecting surfaces in a beam path of an interferometer. Interferometer systems and methods employing light of such short coherence length are also referred to as white light interferometer
25 systems and method, or OCT (optical coherence tomography) interferometer systems and methods. Examples of such type of interferometer systems are disclosed in JP 2001 255 115 A or in the article of Y.N.Ning et al., "Fringe beating effects induced by misalignment in a white-light interferometer
30 Measurement", Science and Technology, Vol. 7, pages 700 to 705, 1996.

The method illustrated above with reference to figure 5 may be applied to meniscus lenses having two surfaces having a
35 common center of curvature. This will result in interference patterns generated by interfering wavefronts reflected back

from the first and second surfaces of such a meniscus lens. It is then possible to slightly tilt a reference surface of the interferometer such that wavefronts reflected back therefrom do not contribute to the interference (see figure 5b). It is also possible to use an interferometer and method as disclosed in US 5,488,477 or Appendix A (WO 03/002933) or a white light interferometer and method.

It is to be noted that all of the method steps illustrated in the figures 1, 3 and 5 may be performed in an arbitrary sequence.

Further, if the surface to be qualified is different from the surfaces of the auxiliary substrate and the auxiliary mirror (see figures 1f, 3f and 5f) it will not be necessary to perform the steps shown in figure 1a, 3a and 5a. These steps will have to be performed if the surfaces errors of one of the surfaces of the auxiliary substrate or the auxiliary mirror are to be determined.

In the above, where maps of surface errors are determined by an interferometric measurement any method for interferogram evaluation may be used. Possible applicable methods are disclosed in the book edited by Daniel Malacara, Optical Shop Testing, 2nd edition, Wiley interscience Publication (1992). Further, methods of phase shifting interferometry (PSI) may be applied, wherein a plurality of interferograms are analyzed for producing a surface map. Examples of phase shifting interferometry are also presented in the book mentioned above by Malacara. The phase shift is advantageously generated by varying the wavelength of the light providing the interferometric measuring beam using a wavelength tunable light source.

It is to be noted that among the determined surface errors mentioned above, those components of the surface errors are

absolutely determined which have an even symmetry with respect to the axis around which substrate 21 is flipped between steps a and c in figures 1, 3 and 5. The rotationally symmetric components of the errors may be obtained by an analysis involving e.g. Zernike polynomials.

Further, steps 1d and 1e as well as 5d and 5e or 3d and 3e may be performed simultaneously by choosing the diameter of mirror surface 31 or 31a or 31b respectively larger than the diameter of substrate 21, 21a, 21b respectively. This procedure eliminates drifts of the interferometer which otherwise could occur between steps d and e.

In the above illustrated embodiments the surface to be manufactured is a perfectly flat surface or a perfectly spherical surface, respectively. It is to be noted however, that the surfaces to be manufactured may be different from such shapes. This may involve using target shapes which are different from the perfectly flat or spherical shape for manufacturing surfaces with a shape corresponding to that of the target shape. For instance, the target surface shape of the optical surface to be manufactured may differ from a surface corresponding to the perfectly flat or spherical surface by a position dependent amount h_{i*} representing a predetermined input offset. In such instance equations (7), (8), (12) and (13) may be rewritten as:

$$h_1 = \frac{1}{4} (2W_1 - W_2 - W_3 + W_D) - h_{i1}, \quad (7')$$

$$h_2 = \frac{1}{4} (-W_2 + W_3 + W_D) - h_{i2}, \quad (8')$$

$$h_0 = \frac{1}{2} (W_6 - W_{int}) - h_{i0}, \quad (12')$$

$$h_M = \frac{1}{4} (2W_4 - W_2 - W_3 + W_D) - h_{iM}. \quad (13')$$

h_{i*} may represent offsets such as a defocus, i.e. a paraboloidal deviation, an aspherical surface shape, or others. Thus, it is possible to manufacture e.g. a high precision aspherical surface which is close to a flat surface

or a spherical surface, respectively. If the surface to be manufactured is a simple surface having a shape close to the perfectly flat or spherical shape, the input offset will be set to zero as previously described with respect to equations (7), (8), (12) and (13) and with reference to figure 2. However, the case of one or more offsets being different from zero are an integral part of the preferred embodiments of the invention.

It is further to be noted that the optical components involved in the above interferometric methods are subject to gravity during measurement. This may result in deformations of the surfaces of those components which are fixed in suitable mounts for arranging the components within the beam path of the interferometer. Even though the optical axis is oriented horizontally in figures 1, 3 and 5, it is also possible to perform the same measurements with an optical axis oriented vertically in the gravitational field. In any event, it is possible to use mathematical methods to simulate deformations of the optical components in the gravitational field. One such method is known as FEM ("finite element method"). All determinations of optical properties and deviations illustrated above may involve taking into account results of such mathematical methods for correcting and/or improving the determined results.

Therefore, while the present invention has been shown and described herein in what is believed to be the most practical and preferred embodiments, it is recognized that departures can be made therefrom within the scope of the invention, which is therefore not be limited to the details disclosed herein but is to be accorded the full scope of the claims so as to embrace any and all equivalent methods and apparatus.